

**30N20-HC**

Preliminary

Power MOSFET**30A, 200V N-CHANNEL
POWER MOSFET****DESCRIPTION**

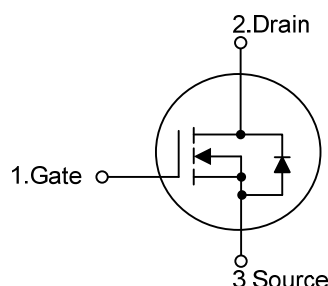
The UTC **30N20-HC** is a N-channel enhancement MOSFET using UTC's advanced technology to provide the customers with perfect $R_{DS(ON)}$, high switching speed, high current capacity and low gate charge.

The UTC **30N20-HC** is universally applied in low voltage such as automotive, high efficiency switching for AC/DC converters and DC motor control, etc.

FEATURES

* $R_{DS(ON)} \leq 60 \text{ m}\Omega$ @ $V_{GS}=10\text{V}$, $I_D=15\text{A}$

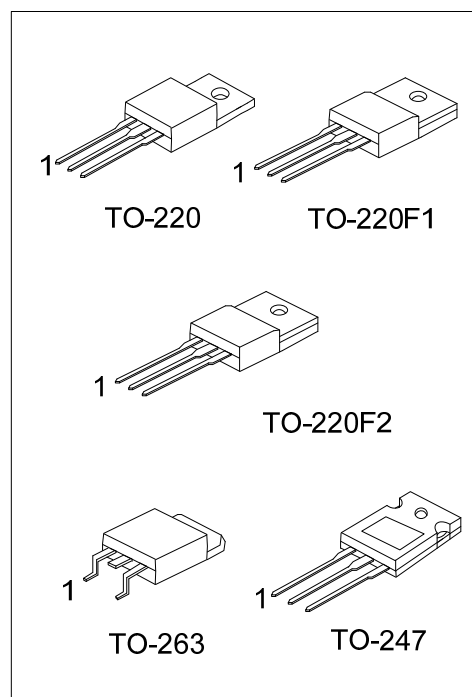
* High Switching Speed

SYMBOL**ORDERING INFORMATION**

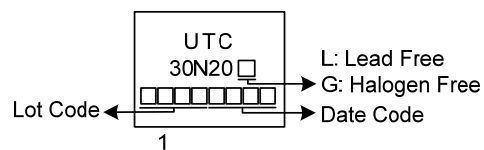
Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
30N20L-TA3-T	30N20G-TA3-T	TO-220	G	D	S	Tube
30N20L-TF1-T	30N20G-TF1-T	TO-220F1	G	D	S	Tube
30N20L-TF2-T	30N20G-TF2-T	TO-220F2	G	D	S	Tube
30N20L-TQ2-T	30N20G-TQ2-T	TO-263	G	D	S	Tube
30N20L-TQ2-R	30N20G-TQ2-R	TO-263	G	D	S	Tape Reel
30N20L-T47-T	30N20G-T47-T	TO-247	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source

30N20G-TA3-T (1) Packing Type (2) Package Type (3) Green Package	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2 TQ2: TO-263, T47: TO-247 (3) G: Halogen Free and Lead Free, L: Lead Free
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■ MARKING



■ **ABSOLUTE MAXIMUM RATINGS** (unless otherwise specified)

PARAMETER			SYMBOL	RATINGS	UNIT
Drain-Source Voltage			V _{DSS}	200	V
Gate-Source Voltage			V _{GSS}	±30	V
Continuous Drain Current	Continuous	T _A =25°C	I _D	30	A
		T _A =100°C		18	A
	Pulsed		I _{DM}	60	A
Single Pulsed Avalanche Current			I _{AS}	86	A
Single Pulsed Avalanche Energy (Note 3)			E _{AS}	1411	mJ
Peak Diode Recovery dv/dt (Note 4)			dv/dt	4.7	V/ns
Power Dissipation	TO-220/TO-263		P _D	232	W
	TO-220F1/TO-220F2			55	W
	TO-247			250	W
Junction Temperature			T _J	+150	°C
Storage Temperature			T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. $L=30\text{mH}$, $I_{AS}=9.7\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_J = 25^{\circ}\text{C}$

4. $I_{SD}\leq 30\text{A}$, $di/dt\leq 200\text{A}/\mu\text{s}$, $V_{DD}\leq BV_{DSS}$, Starting $T_J = 25^{\circ}\text{C}$

■ **THERMAL DATA**

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F1	θ_{JA}	62.5	$^{\circ}\text{C}/\text{W}$
	TO-220F2/TO-263			
	TO-247		50	$^{\circ}\text{C}/\text{W}$
Junction to Case	TO-220/TO-263	θ_{JC}	0.53	$^{\circ}\text{C}/\text{W}$
	TO-220F1/TO-220F2		2.2	$^{\circ}\text{C}/\text{W}$
	TO-247		0.5	$^{\circ}\text{C}/\text{W}$

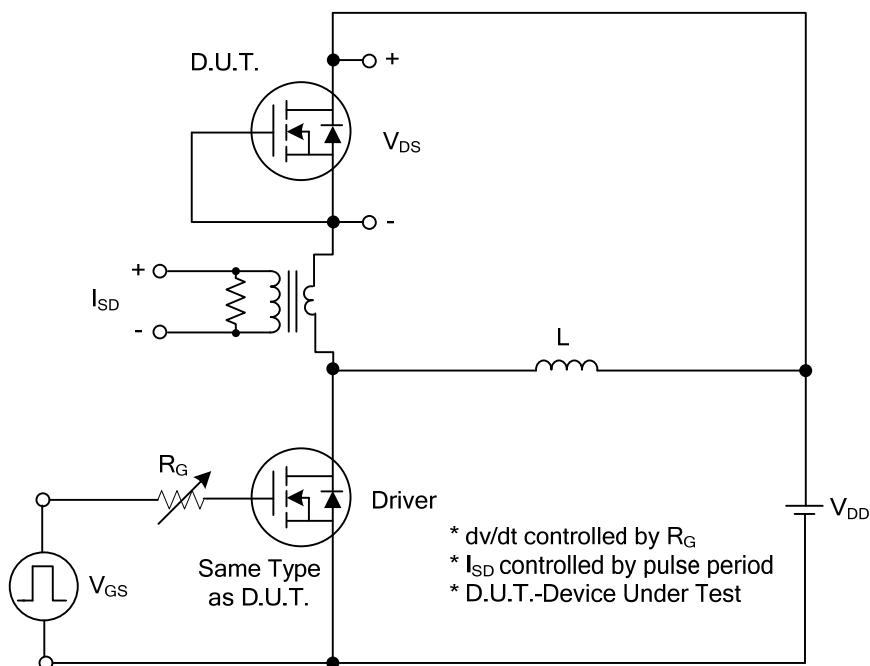
ELECTRICAL CHARACTERISTICS

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μA, V _{GS} =0V	200			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =200V, V _{GS} =0V			10	μA
Gate-Source Leakage Current	Forward	I _{GSS}	V _{GS} =+30V, V _{DS} =0V			+100	nA
	Reverse		V _{GS} =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250μA	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =15A			60	mΩ
DYNAMIC PARAMETERS							
Input Capacitance		C _{ISS}	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		3340		pF
Output Capacitance		C _{OSS}			950		pF
Reverse Transfer Capacitance		C _{RSS}			240		pF
SWITCHING PARAMETERS							
Total Gate Charge		Q _G	V _{DS} =160V, V _{GS} =10V, I _D =30A I _G =1mA (Note 1, 2)		85		nC
Gate to Source Charge		Q _{GS}			22		nC
Gate to Drain Charge		Q _{GD}			28		nC
Turn-ON Delay Time		t _{D(ON)}	V _{DD} =100V, V _{GS} =10V, I _D =30A, R _G =25Ω (Note 1, 2)		40		ns
Rise Time		t _R			55		ns
Turn-OFF Delay Time		t _{D(OFF)}			210		ns
Fall-Time		t _F			58		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I _S				30	A
Maximum Body-Diode Pulsed Current		I _{SM}				60	A
Drain-Source Diode Forward Voltage		V _{SD}	I _S =30A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time		t _{rr}	I _S =30A, V _{GS} =0V, dI _F /dt=100A/μs		210		ns
Reverse Recovery Charge		Q _{rr}	(Note 1)		1.7		μC

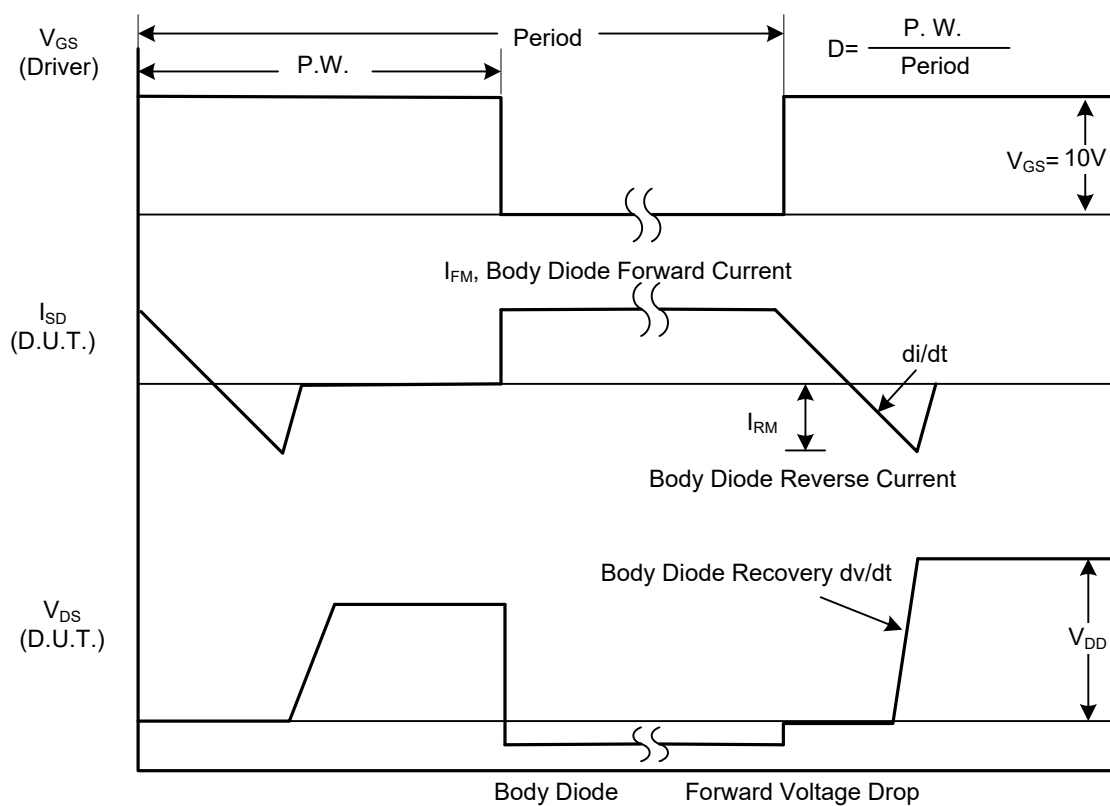
Notes: 1. Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

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